

Fast CMOS Latched Transceivers

Product Features:

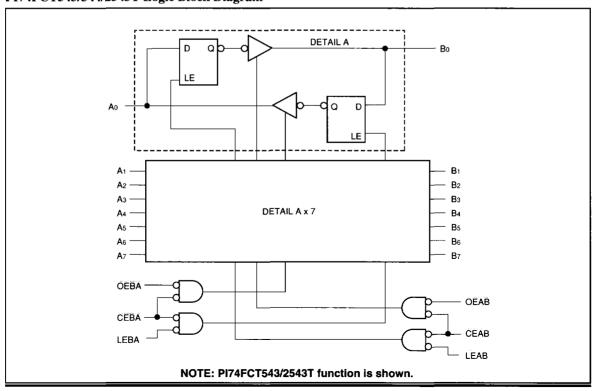
- PI74FCT543T/544/2543T is pin compatible with bipolar FASTTM Series at a higher speed and lower power consumption
- 25Ω series resistor on all outputs
- · TTL input and output levels
- · Low ground bounce outputs
- · Extremely low static power
- · Hysteresis on all inputs
- Industrial operating temperature range: -40°C to +85°C
- · Packages available:
 - 24-pin 300 mil wide plastic DIP (P24)
 - 24-pin 150 mil wide plastic QSOP (Q24)
 - 24-pin 150 mil wide plastic TQSOP (R24)
 - 24-pin 300 mil wide plastic SOIC (S24)
- · Device models available on request

Product Description:

Pericom Semiconductor's PI74FCT series of logic circuits are produced in the Company's advanced 0.8 micron CMOS technology, achieving industry leading speed grades. All PI74FCT2XXX devices have a built-in 25 ohm series resistor on all outputs to reduce noise because of reflections, thus eliminating the need for an external terminating resistor.

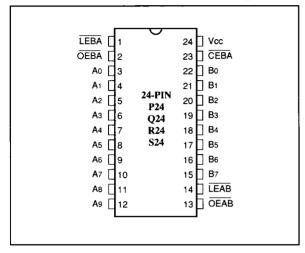
The PI74FCT543T/544T and PI74FCT2543T is an 8-bit wide non-inverting transceiver designed with two sets of eight D-type latches with separate input and output controls for each set. For data flow from A to B, for example, the A-to-B Enable (CEAB) input must be LOW in order to enter data from A0–A7 or to take data from B0–B7, as indicated in the Truth Table. With CEAB LOW, a LOW signal makes the A-to-B latches transparent; a subsequent LOW-to-HIGH transition of the LEAB signal puts the A latches in the storage mode and their outputs no longer change the A inputs. With CEAB and OEAB both LOW, the 3-state B output buffers are active and reflect the data present at the output of the A latches. Control of data from B to A is similar, but uses the CEAB, LEAB, and OEAB inputs. The PI74FCT543T is a non-inverting of the PI74FCT544T.

PI74FCT543/544/2543T Logic Block Diagram





PI74FCT543/544/2543T Product Pin Configuration



Product Pin Description

Pin Name	Description
OEAB	A-to-B Output Enable Input (Active LOW)
OEBA	B-to-A Output Enable Input (Active LOW)
CEAB	A-to-B Enable Input (Active LOW)
CEBA	B-to-A Enable Input (Active LOW)
LEAB	A-to-B Latch Enable Input (Active LOW)
LEBA	B-to-A Latch Enable Input (Active LOW)
A0-A7	A-to-B Data Inputs or B-to-A 3-State Outputs
B0-B7	B-to-A Data Inputs or A-to-B 3-State Outputs
GND	Ground
Vcc	Power

PI74FCT543/2543T Truth Table (Non-Inverting)^(1,2) For A-to-B (Symmetric with B-to-A)

Inputs			Latch Status	Output Buffers
CEAB	LEAB	OEAB	A-to-B	B0-B7
Н	_	_	Storing	High-Z
_	Н		Storing	_
_	_	Н		High Z
L	L	L	Transparent	Current A Inputs
L	Н	L	Storing	Previous* A Inputs

- 1. *Before LEAB LOW-to-HIGH Transition
 - H = HIGH Voltage Level
 - L = LOW Voltage Level
 - = Don't Care or Irrevelant
- A-to-B data flow shown; B-to-A flow control is the same, except using CEBA, LEBA, and OEBA.

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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied40°C to +85°C
Supply Voltage to Ground Potential (Inputs & Vcc Only)0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only)0.5V to +7.0V
DC Input Voltage0.5V to +7.0V
DC Output Current
Power Dissipation 0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, $TA = -40^{\circ}C$ to $+85^{\circ}C$, $VCC = 5.0V \pm 5\%$)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ ⁽²⁾	Max.	Units	
Vон	Output HIGH Voltage	Vcc = Min., Vin = Vih or Vil	Iон = −15.0 mA	2.4	3.0		V
Vol	Output LOW Current	Vcc = Min., Vin = Vih or Vil	Iol = 64 mA		0.3	0.55	V
Vol	Output LOW Current	Vcc = Min., Vin = Vih or Vil	$IoL = 12 \text{ mA } (25\Omega \text{ Series})$		0.3	0.50	V
Vih	Input HIGH Voltage	Guaranteed Logic HIGH Level		2.0			v
Vil	Input LOW Voltage	Guaranteed Logic LOW Level				0.8	V
Іін	Input HIGH Current	(Except I/O pins) Vcc = Max.	$V_{IN} = V_{CC}$			1	μA
IIL	Input LOW Current	(Except I/O pins) Vcc = Max.	V _{IN} = GND			-1	μА
Іін	Input HIGH Current	(I/O pins Only) Vcc = Max.	VIN = VCC			1	μА
In.	Input LOW Current	(I/O pins Only) Vcc = Max.	Vin = GND			-1	μA
Іоzн	High Impedance	Vcc = Max.	Vout = 2.7V	*		1	μA
Iozl	Output Current		Vout = 0.5V			-1	μА
Vik	Clamp Diode Voltage	$V_{CC} = Min., I_{IN} = -18 \text{ mA}$			-0.7	-1.2	V
Ioff	Power Down Disable	$V_{CC} = GND$, $V_{OUT} = 4.5V$	_		100	μA	
Ios	Short Circuit Current	$V_{CC} = Max.^{(3)}, V_{OUT} = GND$	-60	-120		mA	
Vн	Input Hysteresis				200		mV

Capacitance ($T_A = 25^{\circ}C$, f = 1 MHz)

Parameters(4)	Description	Test Conditions	Тур	Max.	Units
Cin	Input Capacitance	Vin=0V	6	10	pF
Соит	Output Capacitance	Vouτ=0V	8	12	pF

Notes:

- 1. For Max, or Min, conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, $+25^{\circ}C$ ambient and maximum loading.
- 3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 4. This parameter is determined by device characterization but is not production tested.



Power Supply Characteristics

Parameters	Description	Test Conditions	(1)	Min.	Typ ⁽²⁾	Max.	Units µA
Icc	Quiescent Power Supply Current	Vcc = Max.	Vin = GND or Vcc		0.1	500	
ΔΙcc	Supply Current per Input @ TTL HIGH	Vcc = Max.	$V_{IN} = 3.4V^{(3)}$		0.5	2.0	mA
Ісев	Supply Current per Input per MHz ⁽⁴⁾	Vcc = Max., Outputs Open CEAB and OEAB = GND CEBA = VCC One Input Toggling 50% Duty Cycle	Vin = Vcc Vin = GND		0.15	0.25	mA/ MHz
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max., Outputs Open fcp = 10 MHz (LEAB)	Vin = Vcc Vin = GND		1.5	3.5 ⁽⁵⁾	mA
		50% Duty Cycle CEAB and OEAB = GND CEBA = Vcc fi = 5 MHz One Bit Toggling	V _{IN} = 3.4V V _{IN} = GND		2.0	5.5 ⁽⁵⁾	
		Vcc = Max., Outputs Open fcp = 10 MHz (LEAB)	Vin = Vcc Vin = GND		3.8	7.3 ⁽⁵⁾	
		50% Duty Cycle CEAB and OEAB = GND CEBA = Vcc Eight Bits Toggling fi = 2.5 MHz 50% Duty Cycle	Vin = 3.4V Vin = GND		6.0	16.3 ⁽⁵⁾	

Notes:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device.

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- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Per TTL driven input ($V_{IN} = 3.4V$); all other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of the Icc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC

 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_1 N_1)$

Icc = Quiescent Current

 Δ Icc = Power Supply Current for a TTL High Input (ViN = 3.4V)

DH = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

ICCD = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

fcp = Clock Frequency for Register Devices (Zero for Non-Register Devices)

fi = Input Frequency

Ni = Number of Inputs at fi

All currents are in milliamps and all frequencies are in megahertz.



PI74FCT543/2543T (non-inverting) Switching Characteristics over Operating Range

			543T/2543T Com.		543AT/2543AT Com.		543CT/2543CT Com.		543DT Com.		
Parameters											
	Parameters	Description	Conditions(1)	Min	Max	Min	Max	Min	Max	Min	Max
tplh	Propagation Delay Transparent	CL = 50 pF	2.5	8.5	2.5	6.5	2.5	5.3	2.5	4.4	ns
t PHL	Mode An to Bn or Bn to An	$R_L = 500\Omega$									
tplh	Propagation Delay		2.5	12.5	2.5	8.0	2.5	7.0	2.5	5.0	ns
tphl.	LEBA to An, LEAB to Bn										
tpz.h	Output Enable Time		2.0	12.0	2.0	9.0	2.0	8.0	2.0	5.4	ns
tPZL	OEBA or OEAB to An or Bn										
	CEBA or CEAB to An or Bn										
tpz.h	Output Disable Time(3)	-	2.0	9.0	2.0	7.5	2.0	6.5	2.0	4.3	ns
tPZL	OEBA or OEAB to An or Bn										
	CEBA or CEAB to An or Bn										
tsu	Setup Time, HIGH or LOW	-	3.0		2.0	_	2.0		1.5	_	ns
	An or Bn to LEBA or LEAB										
tн	Hold Time, HIGH or LOW		2.0	_	2.0	_	2.0	_	1.5		ns
	An or Bn to LEBA or LEAB	j									
tw	LEBA or LEAB Pulse Width LOW(3)		5.0	_	5.0		5.0		3.0	-	ns

PI74FCT544T (inverting) Switching Characteristics over Operating Range

			54	4T	544	IAT	544	СT	
			Com.		Com.		Com.		1
Parameters	Description	Conditions(1)	Min	Max	Min	Max	Min	Max	Unit
tplh	Propagation Delay Transparent	Cı. = 50 pF	2.5	8.5	2.5	6.5	2.5	5.3	ns
tphl.	Mode An to Bn or Bn to An	$RL = 500\Omega$							
t PLH	Propagation Delay		2.5	12.5	2.5	8.0	2.5	7.0	ns
tphl.	LEBA to An, LEAB to Bn							1	
tpzh	Output Enable Time		2.0	12.0	2.0	9.0	2.0	8.0	ns
tPZL	OEBA or OEAB to An or Bn								
	CEBA or CEAB to An or Bn								
tpzh	Output Disable Time(3)		2.0	9.0	2.0	7.5	2.0	6.5	ns
tpzl.	OEBA or OEAB to An or Bn							ļ	
	CEBA or CEAB to An or Bn							į	
tsu	Setup Time, HIGH or LOW		3.0	_	2.0	_	2.0	_	ns
	An or Bn to LEBA or LEAB								
tH	Hold Time, HIGH or LOW		2.0	_	2.0		2.0	_	ns
	An or Bn to LEBA or LEAB								
tw	LEBA or LEAB Pulse Width LOW(3)		5.0	-	5.0	_	5.0		ns

Notes:

- 1. See test circuit and wave forms.
- 2. Minimum limits are guaranteed but not tested on Propagation Delays.
- 3. This parameter is guaranteed but not production tested.

Pericom Semiconductor Corporation

2380 Bering Drive • San Jose, CA 95131 • 1-800-435-2336 • Fax (408) 435-1100 • http://www.pericom.com 110